LNJ801TPSJA

Direct Mounting

φ3.2 mm

Absolute Maximum Ratings $T_a = 25^{\circ}C$

Parameter	Symbol	Rating	Unit	
Power dissipation	P _D	90	mW	
Forward current	I _F 30		mA	
Pulse forward current *	I _{FP}	150	mA	
Reverse voltage	V _R	3	V	
Operating ambient temperature	T _{opr}	-25 to +85	°C	
Storage temperature	T _{stg}	-30 to +100	°C	

Lighting Color

• Soft Orange

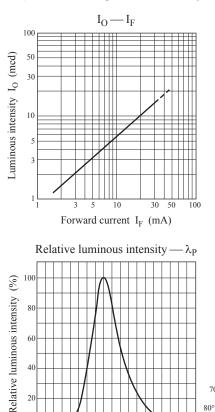
Note) *: The conditon of I_{FP} is duty 10%, pulse width 10 ms.

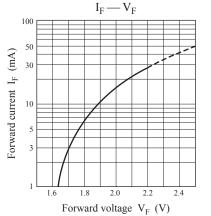
Electro-Optical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Luminous intensity	I _O	$I_F = 20 \text{ mA}$	3.0	10.0		mcd
Reverse current	I _R	$V_R = 3 V$			10	μΑ
Forward voltage	V _F	$I_F = 20 \text{ mA}$		2.1	2.8	V
Peak emission wavelength	$\lambda_{\rm P}$	$I_F = 20 \text{ mA}$		610		nm
Spectral half band width	Δλ	$I_F = 20 \text{ mA}$		40		nm

In

Note) Be careful of the product destruction by static electricity.





Directive characteristics

60 70

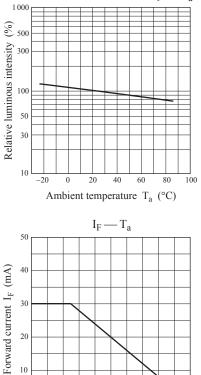
809

90°

100 80 60 40 20

700

Relative luminous intensity -Ta



10

0 L 0

20

40

60

Ambient temperature T_a (°C)

80

80° 909

600

650

Peak emission wavelength λ_P (nm)

550

80

Relative luminous intensity (%)

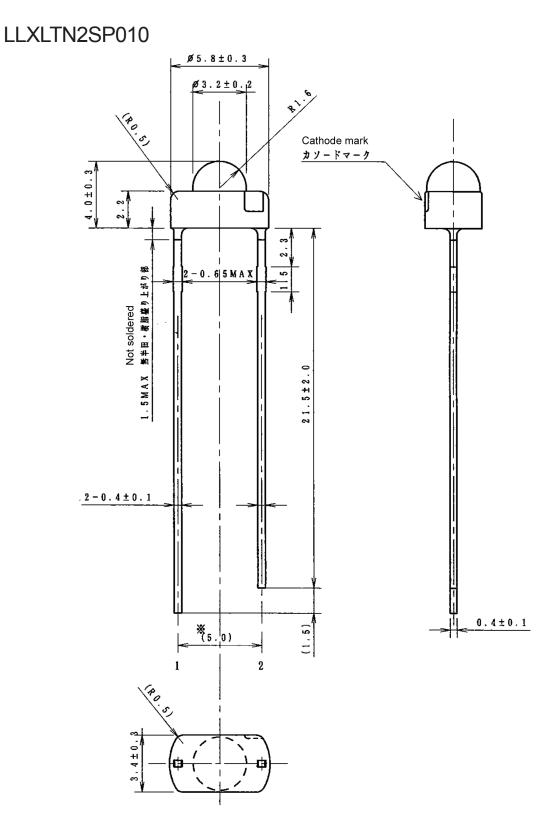
40 60 80 100

20

100

LNJ801TPSJA

Package (Unit: mm)



• Pin name

1: Anode

2: Cathode

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